

LUMAWISE | Inverted Thru-Board

TE Internal #: 2213188-1 Poke-In Connectors, Board-to-Board, 2 Position, .129 in [3.3 mm] Centerline, Printed Circuit Board, Height .364 in [9.25 mm], Inverted Thru-Board

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Connectors > Lighting Connectors > Poke-In Connectors



Connector System: Board-to-Board

Number of Positions: 2

Centerline (Pitch): 3.3 mm [.129 in]

Sealable: No

Connector & Contact Terminates To: Printed Circuit Board

Features

Product Type Features

Lighting Interconnect Level	Level 2
Connector Type	Header
Product Type	Connector



Glow Wire Rating	Standard Part - Not Glow Wire	
Product Line	ITB Card Edge Connector	
Connector System	Board-to-Board	
Sealable	No	
Connector & Contact Terminates To	Printed Circuit Board	
Configuration Features		
Pre-Designed Cables Available	No	
Number of Rows	1	
Number of Positions	2	
Electrical Characteristics		
Operating Voltage	400 VAC	
Body Features		
Header Mating Direction	Inverted	
Contact Features		
Contact Termination Area Plating Finish	Matte	

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Contact Mating Area Plating Material	Tin	
Stamped and Formed	Yes	
Contact Mating Area Plating Thickness	2 μm[78.74 μin]	
Contact Layout	Inline	
Contact Termination Area Plating Thickness	2 μm[78.74 μin]	
Contact Termination Area Plating Material	Tin-Lead over Nickel	
Contact Mating Area Plating Material Finish	Matte	
Contact Current Rating (Max)	3 A	
Termination Features		
Termination Method to Printed Circuit Board	Surface Mount	
Mechanical Attachment		
Mating Alignment	With	
Mating Retention	Without	
PCB Mount Alignment	Without	
PCB Mount Retention	With	
PCB Mount Retention Type	Boardlock	
Connector Mounting Type	Board Mount	

Housing Features

Housing Color	Natural			
Centerline (Pitch)	3.3 mm[.129 in]			
Dimensions				
Width	10.7 mm[.421 in]			
Length	7.5 mm[.295 in]			
Connector Height	9.25 mm[.364 in]			
Usage Conditions				
UV Exposure Rated	No			
SMT Soldering Temperature	220 °C[428 °F]			
Operating Temperature Range	-40 – 130 °C[-40 – 266 °F]			
Operation/Application				
SMT Compatible	Yes			
Circuit Application	Power			
Identification Marking				

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Circuit Identification Feature	Without
Industry Standards	
Agency/Standard Number	C22.2 No. 182.3-M1987, UL 1977
UL File Number	E28476
Agency/Standard	CSA, UL
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Method	SMT Pocket Tape
Product Compliance For compliance documentation, visit the product page on TE.com> EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2022

Not Yet Reviewed

Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free

Solder Process Capability

Halogen Content

Reflow solder capable to 260°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts

Poke-In Connectors, Board-to-Board, 2 Position, .129 in [3.3 mm] Centerline, Printed Circuit Board, Height .364 in [9.25 mm], Inverted Thru-Board





Also in the Series Inverted Thru-Board



Customers Also Bought

TE Part #YDTS24W25-35PNV001

RECP ASSY



TE Part #111547-2	TE Part #207516-6	TE Part #1-87133-1	TE Part #YDTS24W25-29PNV001
014 UNIV I/O STRAIN RELIEF	25 HD20 RCPT ASSY (CN)	12 LOCKING CLIP HSG DR .100CL	RECP ASSY
		ETE	

TE Part #5-208743-1

AMPLIMITE, ASY, PLUG, 24C7 POS

TE Part #YACT20MC35SCV00100

SQUARE FLANGE RECEPTACLE

TE Part #YDJT14E17-35PNV001 RECP ASSY

TE Part #87133-9

08 LOCKING CLIP HSG DR .100CL

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Documents

Product Drawings Assembly, ICE Connector 1.0 PCB w/o cap

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_2213188-1_A.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_2213188-1_A.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_2213188-1_A.3d_stp.zip

English

By downloading the CAD file I accept and agree to the Terms and Conditions of use.

Datasheets & Catalog Pages Inverted Thru Board Interconnects

Inverted Thru Board Interconnects

English

Inverted Card Edge & Poke In Connector Brochure

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English

Product Specifications Application Specification

English

Agency Approvals Inverted Thru Board Connectors to IEC 60998

English